

Single P-channel MOSFET

ELM17401FA-S

General description

ELM17401FA-S uses advanced trench technology to provide excellent $R_{ds(on)}$, low gate charge and operation with gate voltages as low as 2.5V.

Features

- $V_{ds} = -30V$
- $I_d = -1.2A$ ($V_{gs} = -10V$)
- $R_{ds(on)} < 150m\Omega$ ($V_{gs} = -10V$)
- $R_{ds(on)} < 200m\Omega$ ($V_{gs} = -4.5V$)
- $R_{ds(on)} < 280m\Omega$ ($V_{gs} = -2.5V$)

Maximum absolute ratings

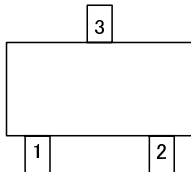
Parameter		Symbol	Limit	Unit	Note
Drain-source voltage		V_{ds}	-30	V	
Gate-source voltage		V_{gs}	± 12	V	
Continuous drain current	$T_a = 25^\circ C$	I_d	-1.2	A	1
	$T_a = 70^\circ C$		-1.0		
Pulsed drain current		I_{dm}	-10	A	2
Power dissipation	$T_a = 25^\circ C$	P_d	0.35	W	1
	$T_a = 70^\circ C$		0.22		
Junction and storage temperature range		T_j, T_{stg}	-55 to 150	$^\circ C$	

Thermal characteristics

Parameter		Symbol	Typ.	Max.	Unit	Note
Maximum junction-to-ambient	$t \leq 10s$	$R\theta_{ja}$	300	360	$^\circ C/W$	1
Maximum junction-to-ambient	Steady-state		350	425	$^\circ C/W$	
Maximum junction-to-lead	Steady-state	$R\theta_{jl}$	280	320	$^\circ C/W$	3

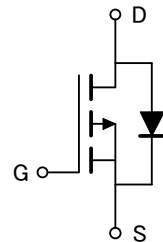
Pin configuration

SC-70 (TOP VIEW)



Pin No.	Pin name
1	GATE
2	SOURCE
3	DRAIN

Circuit



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Electrical characteristics

Ta=25°C

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
STATIC PARAMETERS						
Drain-source breakdown voltage	BV _{dss}	I _d =-250 μA, V _{gs} =0V	-30			V
Zero gate voltage drain current	I _{dss}	V _{ds} =-24V V _{gs} =0V			-1 -5	μA
		T _j =55°C				
Gate-body leakage current	I _{gss}	V _{ds} =0V, V _{gs} =±12V			±100	nA
Gate threshold voltage	V _{gs(th)}	V _{ds} =V _{gs} , I _d =-250 μA	-0.6	-1.0	-1.4	V
On state drain current	I _{d(on)}	V _{gs} =-4.5V, V _{ds} =-5V	-10			A
Static drain-source on-resistance	R _{ds(on)}	V _{gs} =-10V I _d =-1.2A		122 173	150 220	mΩ
		T _j =125°C				
		V _{gs} =-4.5V, I _d =-1.2A		147	200	mΩ
		V _{gs} =-2.5V, I _d =-1A		207	280	mΩ
Forward transconductance	G _{fs}	V _{ds} =-5V, I _d =-1.2A	3.0	4.5		S
Diode forward voltage	V _{sd}	I _s =-1A, V _{gs} =0V		-0.85	-1.00	V
Max. body-diode continuous current	I _s				-0.5	A
DYNAMIC PARAMETERS						
Input capacitance	C _{iss}	V _{gs} =0V, V _{ds} =-15V, f=1MHz		409		pF
Output capacitance	C _{oss}			55		pF
Reverse transfer capacitance	C _{rss}			42		pF
Gate resistance	R _g	V _{gs} =0V, V _{ds} =0V, f=1MHz		12		Ω
SWITCHING PARAMETERS						
Total gate charge	Q _g	V _{gs} =-4.5V, V _{ds} =-15V I _d =-1A		5.06		nC
Gate-source charge	Q _{gs}			0.72		nC
Gate-drain charge	Q _{gd}			1.58		nC
Turn-on delay time	t _{d(on)}	V _{gs} =-10V, V _{ds} =-15V R _l =15 Ω, R _{gen} =3 Ω		6.2		ns
Turn-on rise time	t _r			3.2		ns
Turn-off delay time	t _{d(off)}			41.2		ns
Turn-off fall time	t _f			14.5		ns
Body diode reverse recovery time	t _{rr}	I _f =-1A, dI/dt=100A/μs		13.2		ns
Body diode reverse recovery charge	Q _{rr}	I _f =-1A, dI/dt=100A/μs		5.4		nC

NOTE :

1. The value of R_{θja} is measured with the device mounted on 1in² FR-4 board of 2oz. Copper, in still air environment with Ta=25°C. The value in any given applications depends on the user's specific board design, The current rating is based on the t ≤ 10s thermal resistance rating.
2. Repetitive rating, pulse width limited by junction temperature.
3. The R_{θja} is the sum of the thermal impedance from junction to lead R_{θjl} and lead to ambient.
4. The static characteristics in Figures 1 to 6 are obtained using 80μs pulses, duty cycle 0.5%max.
5. These tests are performed with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with Ta=25°C. The SOA curve provides a single pulse rating.

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Typical electrical and thermal characteristics

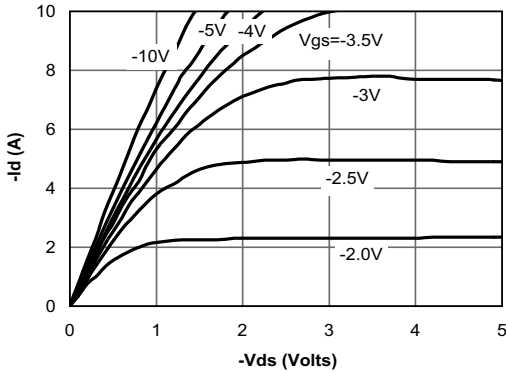


Fig 1: On-Region Characteristics

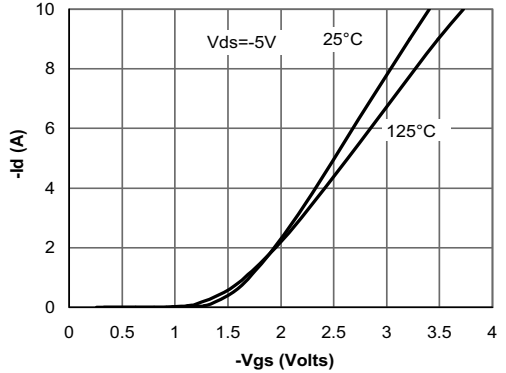


Figure 2: Transfer Characteristics

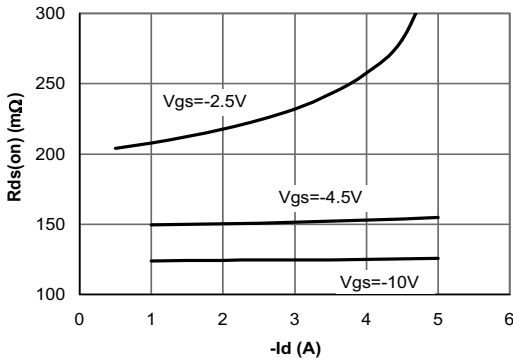


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

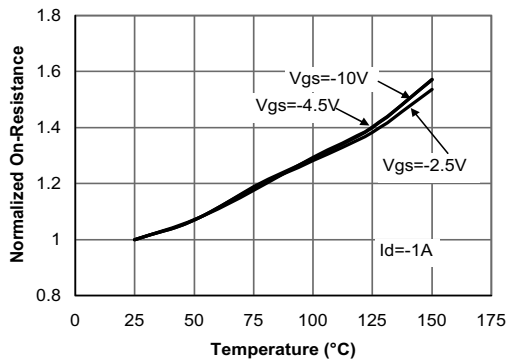


Figure 4: On-Resistance vs. Junction Temperature

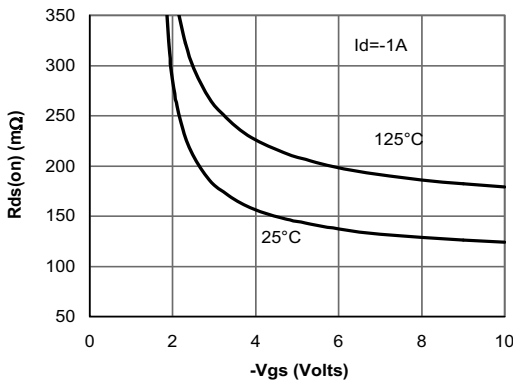


Figure 5: On-Resistance vs. Gate-Source Voltage

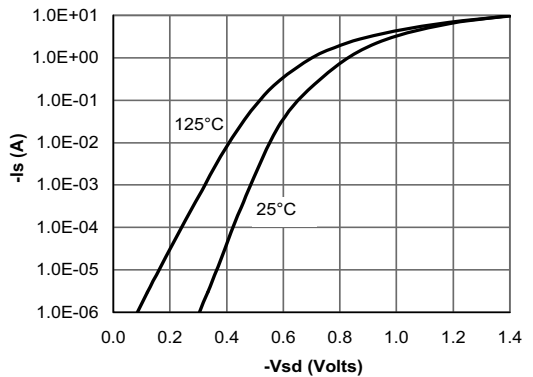


Figure 6: Body-Diode Characteristics

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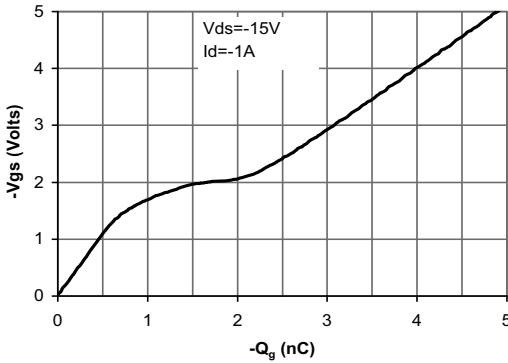


Figure 7: Gate-Charge Characteristics

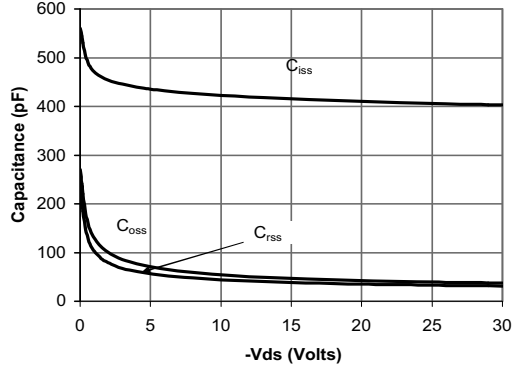


Figure 8: Capacitance Characteristics

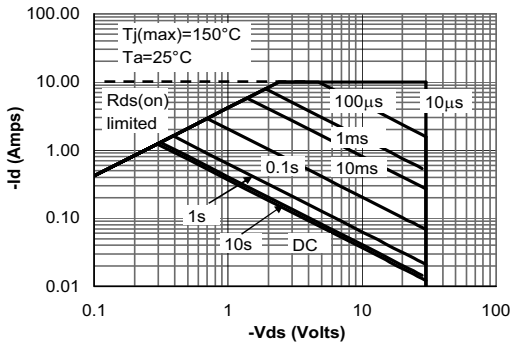


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

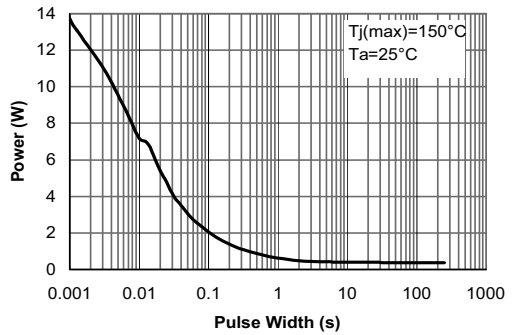


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

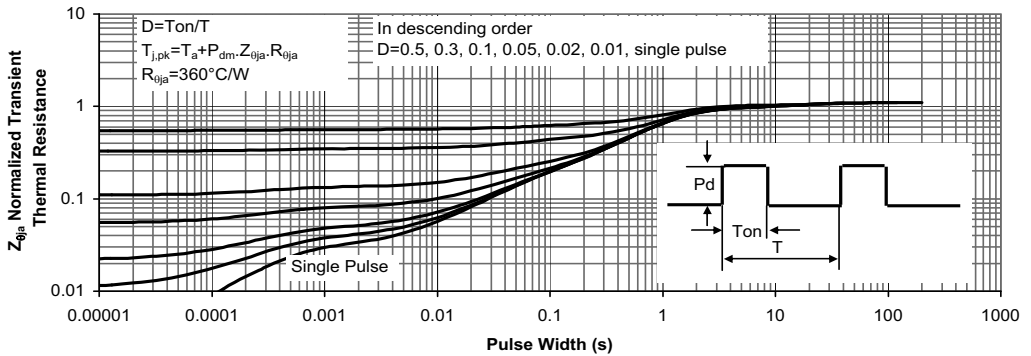


Figure 11: Normalized Maximum Transient Thermal Impedance